Surface Mount Ultrafast Power Rectifier

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (1.05 V Max @ 1.0 A, $T_J = 150$ °C)
- NRVUA and SURA8 Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection:
 - Human Body Model > 4000 V (Class 3)
 - ♦ Machine Model > 400 V (Class C)



ON Semiconductor®

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ULTRAFAST RECTIFIER1 AMPERE, 600 VOLTS



SMA CASE 403D

MARKING DIAGRAM



U4J = Device Code

A = Assembly Location

Y = Year

WW = Work Week

= Pb-Free Package

ORDERING INFORMATION

| | Device | Package | Shipping [†] | | |
|---|--------------|------------------|-----------------------|--|--|
| | MURA160T3G | SMA (Pb-Free) | 5,000/Tape & Reel | | |
| | NRVUA160VT3G | SMA (Pb-Free) | 5,000/Tape & Reel | | |
| Ī | SURA8160T3G | SMA (Pb-Free) | 5,000/Tape & Reel | | |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit | |
|---|--|-------------|------|--|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 600 | V | |
| Average Rectified Forward Current @ T _L = 145°C @ T _L = 110°C | I _{F(AV)} | 1.0 2.0 | A | |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | 30 | А | |
| Operating Junction Temperature Range | TJ | -65 to +175 | °C | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-------------------------------|-----|------|
| Thermal Resistance, Junction–to–Lead (T _L = 25°C) (Note 1) | Psi _{JL} (Note 2) | 24 | °C/W |
| Thermal Resistance, Junction-to-Ambient (Note 1) | $R_{\theta JA}$ | 216 | |

^{1.} Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

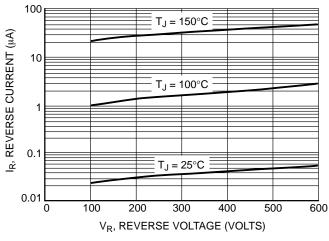
ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------|--------------|------|
| Maximum Instantaneous Forward Voltage (Note 3) ($i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$) | V _F | 1.25 1.05 | V |
| Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, T _J = 25°C) (Rated dc Voltage, T _J = 150°C) | i _R | 5.0 150 | μΑ |
| Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 A/μs) | t _{rr} | 75 | ns |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{2.} In compliance with JEDEC 51, these values (historically represented by R_{BJL}) are now referenced as Psi_{JL}.

^{3.} Pulse Test: Pulse Width = 300 µs, Duty Cycle ≤ 2.0%.



1000

(YE)

TJ = 150°C

TJ = 100°C

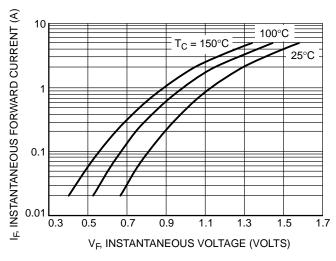
TJ = 25°C

TJ = 25°C

VR, REVERSE VOLTAGE (VOLTS)

Figure 1. Typical Reverse Current

Figure 2. Maximum Reverse Current



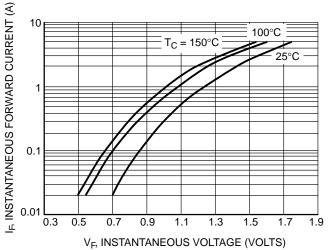


Figure 3. Typical Forward Voltage

Figure 4. Maximum Forward Voltage

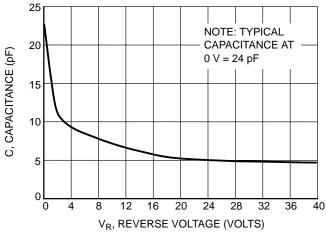


Figure 5. Typical Capacitance

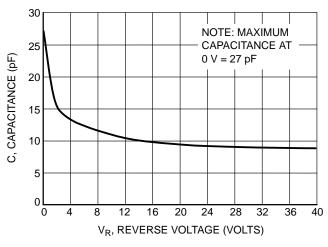


Figure 6. Maximum Capacitance

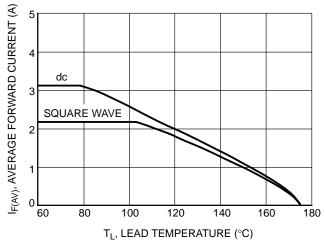


Figure 7. Current Derating, Lead

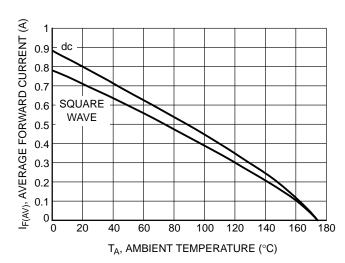


Figure 8. Current Derating, Ambient (FR-4 Board with Minimum Pad)

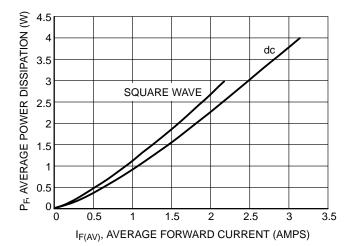
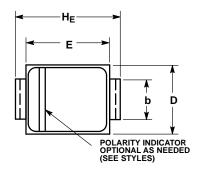


Figure 9. Power Dissipation

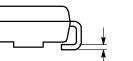
PACKAGE DIMENSIONS

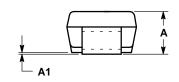
SMA CASE 403D **ISSUE H**



- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L.

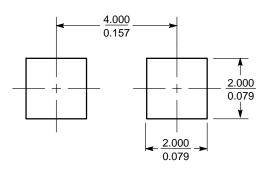
| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 1.97 | 2.10 | 2.20 | 0.078 | 0.083 | 0.087 |
| A1 | 0.05 | 0.10 | 0.20 | 0.002 | 0.004 | 0.008 |
| b | 1.27 | 1.45 | 1.63 | 0.050 | 0.057 | 0.064 |
| С | 0.15 | 0.28 | 0.41 | 0.006 | 0.011 | 0.016 |
| D | 2.29 | 2.60 | 2.92 | 0.090 | 0.103 | 0.115 |
| E | 4.06 | 4.32 | 4.57 | 0.160 | 0.170 | 0.180 |
| HE | 4.83 | 5.21 | 5.59 | 0.190 | 0.205 | 0.220 |
| L | 0.76 | 1.14 | 1.52 | 0.030 | 0.045 | 0.060 |





STYLE 1:
PIN 1. CATHODE (POLARITY BAND)

SOLDERING FOOTPRINT*



SCALE 8:1

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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